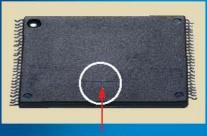


ULTRA-LOW HUMIDITY STORAGE CABINETS 1, 3%RH





Prevent your components from micro-cracking during reflow with proper Ultra-Low Humidity Storage.



Micro-crack

Features

Conforms to IPC/JEDEC J-STD-033B Standard for Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices.

Conforms to IEC-61340-5-1 (ESD) Standard for Handling

- Dehumidifies ICs to prevent micro-cracking and can be used as an alternative to baking
- DXU Model cabinets can maintain 1%RH
- Powerful moisture absorbent is utilized to eliminate the use of nitrogen
- No maintenance is required as moisture absorbent is automatically refreshed
- Cabinets are grounded to prevent static electricity
- Wide range of cabinet sizes available



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Why do components require low humidity storage? McDry™ Prevents Micro-Cracking of IC Packages During Reflow.

The high temperatures involved in vapor phase or reflow passes cause the absorbed moisture to expand rapidly. Micro-cracking occurs in nearly 100% of IC packages containing moisture

during the reflow process. Occurring over an extended period of time, this can cause breakage of wiring and other problems. Micro-cracking can be prevented with storage and dehumidification of IC's using McDry™ as well as resetting the floor life of components according to the IPC/JEDEC J-Std 033b.



Ambient Storage

The plastic packaging used to manufacture surface mount technology devices will absorb moisture from the environment.

Reflow Soldering

Surface peeling between the die pad and the resin is caused by water vapor pressure during reflow.

The high temperatures involved in vapor phase or reflow soldering cause the absorbed moisture to expand rapidly, thus causing internal stress known as "Popcorning".

Surface delamination is likely resulting in shear strain on bond wires and wire necking, micro-cracking extending to the outside of the package.

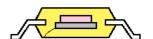












Package Cracking

McDry Applications

Low humidity storage of IC Packages (MSD) which have been removed from moisture barner bags. (To stop the floor life clock of CSPs, BGAs, TQFPs, etc.)



- 1) Low humidity storage of MSDs before and leftover after implementation.
- 2) Low humidity storage of MSDs that have been removed from mounter.
- 3) Low humidity storage of MSDs when writing ROMs.
- Drying and storing multilayer PC boards before and after mounting.



Dry storage of pattern film and prepreg used in the manufacturing of PCBs.



Dry storage of semi-mounted PCBs Effective low humidity storage of PCBs awaiting second-side reflow.





Clean, room temperature drying of liquid crystal glass boards after washing. Results in even drying and prevents contamination.



Dry storage of quartz crystals and electrode adhesives used in the manufacturing of quartz oscillators.



Drying and storing of fiber optics (Micro-lens for WDM) and CCD (Solid-state image



Low humidity storage of electronic components to slow down oxidation.





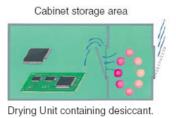
Manufactured for High Performance

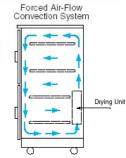


Dehumidifying Principle

Dehumidifying Principle

McDry™ Electronic Drying Storage Cases provide low humidity storage without the use of nitrogen. Humidity is removed from the cabinets by use of a powerful zeolite desiccant. The desiccant is automatically recycled with a heating mechanism and does not require replacement. Moisture absorbed by the zeolite desiccant is vaporized and released outside of the cabinet. Memory shaped metal is utilized for fail proof ventilation. Forced air-flow convection system desiccates the entire cabinet without requiring the use of a fan for optimal dehumidification to take place.





Handling and Storage Guidelines of IC Packages

Storing in 5% RH and 10% RH storage cabinets in accordance with IPC/JEDEC J-STD 033B

In accordance with IPC/JEDEC J-STD-033B, IC packages that have been removed from MBBs must be kept under a condition of 5% or 10% relative humidity to prevent components from absorbing moisture. However, during the mounting process, opening and closing of dry cabinet storage doors may occur frequently in order to remove and replace moisture-sensitive devices. This will allow ambient air to flow into the cabinet and may raise the RH level. To limit this from occurring and to keep the relative humidity inside of the cabinet below 5% or 10% as specified, a consistent, ultra-low humidity storage level is recommended. Therefore, the storage guidelines utilizing the McDry" cabinet corresponding to the repetition of door opening and closing of doors are as follows:

Model	RH level	Frequency of opening-closing of doors	Usage example	
DXU models	1% RH	Once in approx. 20 – 40 mins.	Ultra-low humidity storage of IC's for cabinets that are accessed frequently. Storage of IC packages that require ultra-low humidity storage such as components with high MSL classifications.	
MCU models	3% RH	Once in approx. 1 hr – 2 hrs.	Ultra-low humidity storage of IC's for cabinets that are not accessed frequently. Long-term storage of IC packages and electrical components. Storage of PCBs, etc.	



MCU Model 3%RH



Features

- 1. Can maintain an RH level of 3%
- 2. Equipped with a digital RH Meter
- 3. Locking Doors
- 4. Adjustable shelves

- 5. Loading capacity MCU-201,301,340,580: 110lbs. (50kgs.)
- 6. Grounded to prevent static electricity

Specifications (Note: Specifications are subject to change due to product improvement.)

ITEM MODEL	MCU-201	MCU-301	MCU-401	MCU-340	MCU-580
External	19.69W x 20.87D x 24.80H (in)	19.69W x 24.80D x 47.24H (in)	19.69W x 24.80D x 60.24H (in)	34.65W x 18.11D x 38.58H (in)	34.65W x 31.50D x 38.58H (in)
Dimensions	500W x 530D x 630H (mm)	500W x 630D x 1200H (mm)	500W x 630D x 1530H (mm)	880W x 460D x 980H (mm)	880W x 800D x 980H (mm)
Internal	18.90W x 19.69D x 21.26H (in)	18.90W x 19.69D x 42.52H (in)	18.90W x 19.69D x 55.51H (in)	33.86W x 16.93D x 33.07H (in)	33.86W x 28.74D x 33.07H (in)
Dimensions	480W x 500D x 540H (mm)	480W x 600D x 1080H (mm)	480W x 600D x 1410H (mm)	860W x 430D x 840H (mm)	860W x 730D x 840H (mm)
Capacity	Approx	Approx	Approx	Approx	Approx
	4.767 Cu Feet (135 Liters)	10.946 Cu Feet (310 Liters)	14.124 Cu Feet (400 Liters)	10.593 Cu Feet (300 Liters)	18.361 Cu Feet (520 Liters)
Dry Unit	US-3200	US-4000	US-4000	US-4000	US-5000
Material	Bonderized steel				
	with melamine coating				
Color	lvory	lvory	lvory	lvory	Silver
Doors	1 Door	2 Doors	3 Doors	2 Doors	2 Doors
(Magnetic)	with glass window	with glass windows	with glass windows	with glass windows	with glass windows
Weight	Approx 66 lbs. (30 kgs.)	Approx 132 lbs. (60 kgs.)	Approx 154 lbs. (70 kgs.)	Approx 128 lbs. (58 kgs.)	Approx 176 lbs. (80 kgs.)
Electrical	AC 120V (50/60Hz)				
Requirement	Max 140W	Max 250W	Max 250W	Max 250W	Max 370W
Accessories Included	RH Meter, 4 shelves	RH Meter, 8 shelves	RH Meter, 8 shelves	RH Meter, 3 shelves	RH Meter, 3 shelves



MC Model 3%RH





ltem Model	MC-1001	MC-1002	
External Dimensions	47.24W x 27.56D x 72.83H (in) 1200W x 700D x 1850H (mm)	47.24W x 27.56D x 72.83H (in) 1200W x 700D x 1850H (mm)	
Internal Dimensions	45.28W x 23.62D x 66.93H (in) 1150W x 600D x 1700H (mm)	45.28W x 23.62D x 66.93H (in) 1150W x 600D x 1700H (mm)	
Capacity	Approx 42.372 Cu Feet (1200 Liters)	Approx 42.372 Cu Feet (1200 Liters)	
Dry Unit	US-5000	US-5000	
Material	Bonderized steel with melamine coating	Bonderized steel with melamine coating	
Color	Silver	Silver	
Doors(Magnetic)	6 Doors with glass windows	4 Doors with glass windows	
Weight	Approx 419 lbs. (190 kgs.)	Approx 396 lbs. (180 kgs.)	
Electrical Requirement	AC 120V (50/60Hz) Max 370W	AC 120V (50/60Hz) Max 370W	
Accessories Included	Casters, RH Meter, 5 shelves	Casters, RH Meter, 5 shelves	



Features

- 1. Can maintain an RH level of 3%
- 2. Equipped with a digital RH Meter
- 3. Locking Doors
- 4. Shelves are adjustable and can hold 220lbs. (100kgs.)
- 5. Grounded to prevent static electricity